



600V, 30A, Trench FS II Fast IGBT

General Description

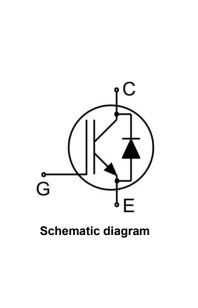
Using NCE's proprietary trench design and advanced FS (Field Stop) second generation technology, the 600V Trench FS II IGBT offers superior conduction and switching performances, and easy parallel operation;

Features

- Trench FSII Technology offering
- Very low V_{CE(sat)}
- High speed switching
- Positive temperature coefficient in V_{CE(sat)}
- Very tight parameter distribution
- High ruggedness, temperature stable behavior

Application

- Air Condition
- Inverters
- Motor drives



Package Marking and Ordering Information

Device	Device Package	Device Marking					
NCE30TD60BT	TO-247	NCE30TD60BT					



TO-247

Absolute Maximum Ratings (Tc=25°C unless otherwise noted)

Symbol	Parameter	arameter Value	
VCES	Collector-Emitter Voltage	600	V
V _{GES}	Gate- Emitter Voltage	±30	V
	Collector Current	60	A
lc	Collector Current @T _c = 100°C	30	A
I _{Cpuls}	Pulsed Collector Current, t _p limited by T _{jmax}	120	A
-	turn off safe operating area,V _{CE} =600V, T _j =175°C	120	A
I _F	Diode Continuous Forward Current @T _c = 100°C	30	A
I _{FM}	Diode Maximum Forward Current	120	A
Power Dissipation @ T _c = 25°C		230	W
PD	Power Dissipation @T _c = 100 °C	115	W
T_{J}, T_{stg}	Operating Junction and Storage Temperature Range	-55 to +175	°C
TL	Maximum Temperature for Soldering	260	°C
t _{sc}	Short circuit withstand time V_{GE} =15V, V_{CC} 400V, Allowed number of short circuits<1000Time between short circuits: \geq 1.0s, T_j \leq 150°C	5	us



NCE30TD60BT

Thermal Characteristic

Symbol	Parameter	Value	Units
R _{θJC}	Thermal Resistance, Junction to case for IGBT	0.65	°C/W
R _{θJC}	Thermal Resistance, Junction to case for Diode	0.99	°C/W
R _{0JA}	Thermal Resistance, Junction to Ambient	40	°C/W

Electrical Characteristics (Tc=25°C unless otherwise noted)

Sumb cl	Devementer	Conditions		Value			
Symbol	mbol Parameter Conditions		Min.	Тур.	Max.	Units	
Static Chara	cteristics				•	I	
V _{(BR)CES}	Collector-Emitter Breakdown Voltage	V _{GE} =0V	,I _{CE} =1mA	600			V
I _{CES}	Collector-Emitter Leakage Current	V _{GE} =0V,	V _{CE} =600V			40	uA
I _{GES(F)}	Gate to Emitter Forward Leakage	V _{GE} =+30	V,V _{CE} =0V			200	nA
I _{GES(R)}	Gate to Emitter Reverse Leakage	V _{GE} =-30	V,V _{CE} =0V			200	nA
V _{CE(sat)}	Collector-Emitter Saturation Voltage	I _C =30A V _{GE} =15V	T _j =25°C T _i =175°C		1.7 1.9	1.9	V V
$V_{\text{GE(th)}}$	Gate Threshold Voltage	Ic=1mA,Vc=VGE		4.0	5.0	6.0	V
Dynamic Cha	aracteristics				•		
Cies	Input Capacitance	- V _{CE} =25V,V _{GE} =0V, f=1MHz			3552		pF
Coes	Output Capacitance				106		
Cres	Reverse Transfer Capacitance				67		
Qg	Total Gate Charge	V _{cc} =480V, I _c =30A, V _{GE} =15V			132		nC
Q _{ge}	Gate to Emitter Charge				28		
Q _{gc}	Gate to Collector Charge				54		
I _{C(SC)}	Short circuit collector current Max.1000 short circuits Time between short circuits: \ge 1.0s	V _{GE} =15V,V _{CC} ≪400V, t _{SC} ≪5us,Tj≪150°C			180		А
Switching Ch	naracteristics						
t _{d(ON)}	Turn-on Delay Time	Vcc=400V,Ic=30A,			19		
tr	Rise Time				17		ne
$t_{\text{d}(OFF)}$	Turn-Off Delay Time				166		ns
t _f	Fall Time	V _{GE} =0/15V, R _g =5Ω,			16		
E_{on}	Turn-On Switching Loss	Inductive Load			0.36		
E_{off}	Turn-Off Switching Loss				0.32		mJ
E _{ts}	Total Switching Loss				0.68		

Electrical Characteristics of the Diode (T_c= 25°C unless otherwise specified)

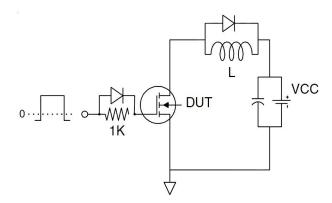
Symbol	Parameter	Conditions	Rating			Unite
		Conditions	Min.	Тур.	Max.	Units
Vfm	Diode Forward Voltage	I⊧=30A		1.75	2.40	V
Trr	Reverse Recovery Time	1 - 20 4		178		ns
I _{RRM}	Diode Peak Reverse Recovery Current	l⊧=30A, di/dt=200A/us		4		А
Qrr	Reverse Recovery Charge	ui/ui-200A/us		0.4		uC
Pulse width t _{tp} ≤380μs,δ≤2%						





Test Circuit

1) Gate Charge Test Circuit



2) Switch Time Test Circuit

2) Definition of switching losses

90% V_{GE}

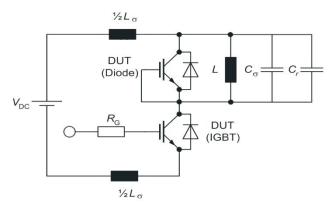
2%

V_{CE} x I_C x dt

 $V_{GE}(t)$

 $i_{\rm c}(t)$

 $V_{CE}(t)$



10% V_{GI}

E_{on} =

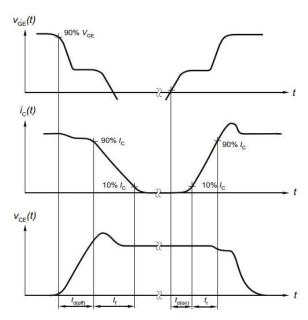
t3

VCE X I

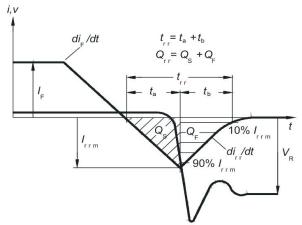
2% V_{CE} t

Switching characteristics

1) Definition of switching times



3) Definition of diode switching characteristics





Typical Electrical and Thermal Characteristics

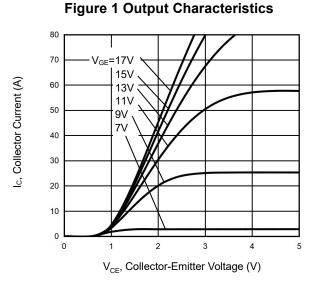
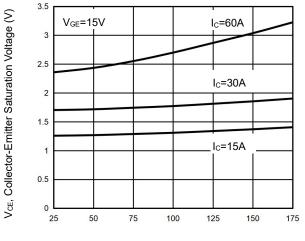
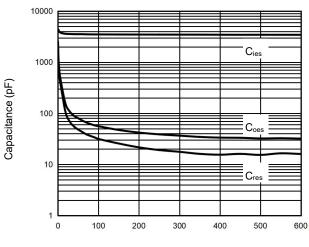


Figure 3 V_{CEsat} vs. Case Temperature



T_J, Junction Temperature (°C)

Figure 5 Capacitance Characteristics



 $V_{\text{CE}},$ Collector-Emitter Voltage (V)

80 V_{CE}=20V 70 Ic, Collector Current (A) 60 25°C 50 150°C 40 30 20 10 0 12 15 9 3 6 V_{GE}, Gate-Emitter Voltage (V)

Figure 2 Transfer Characteristics

Figure 4 Saturation Voltage vs. VGE

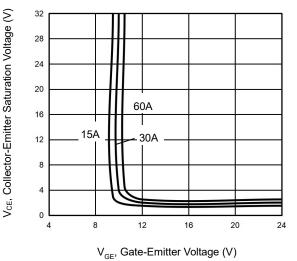
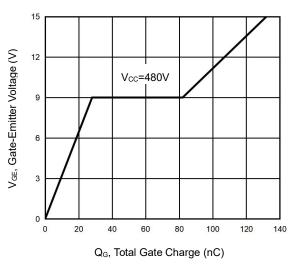


Figure 6 Gate charge waveform





Typical Electrical and Thermal Characteristics

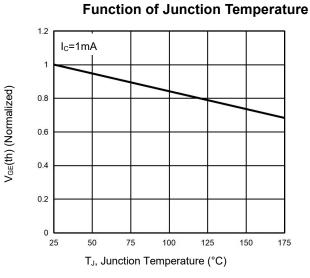
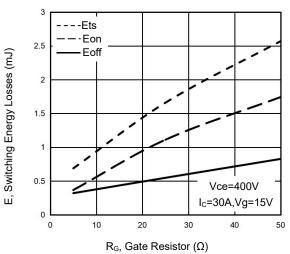
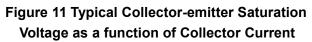


Figure 7 Gate-emitter Threshold Voltage as a

Figure 9 Typical Switching Times as a **Function of Gate Resistor**





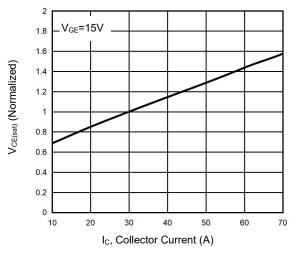


Figure 8 Power Dissipation as a Function of **Case Temperature**

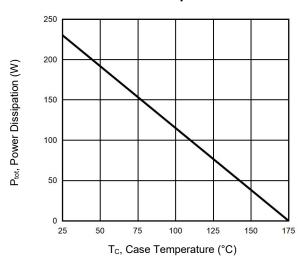


Figure 10 Typical Switching Times as a **Function of Junction Temperature**

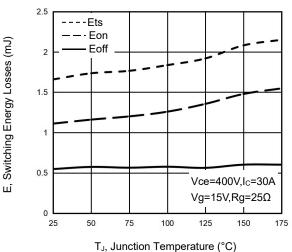
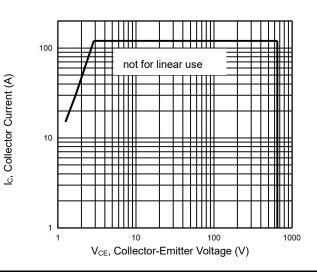
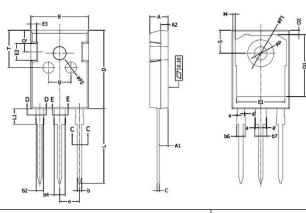


Figure 12 Forward Bias Safe Operating Area





TO-247-P Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
A	4.90	5.10	0.19	0.20	
A1	2.31	2.51	0.09	0.10	
A2	1.90	2.10	0.08	0.09	
а	0.00	0.15	0.00	0.01	
a'	0.00	0.15	0.00	0.01	
b	1.16	1.26	0.05	0.06	
b2	1.96	2.06	0.08	0.09	
b4	2.96	3.06	0.12	0.13	
b6	-	2.25	-	0.09	
b7	-	3.25	-	0.13	
С	0.59	0.66	0.02	0.03	
D	20.90	21.10	0.82	0.83	
D1	16.25	16.85	0.64	0.66	
D2	1.05	1.35	0.04	0.05	
E	15.70	15.90	0.62	0.63	
E1	13.10	13.50	0.52	0.53	
E2	4.40	4.60	0.17	0.18	
E3	2.40	2.60	0.09	0.10	
е	5.436	BSC	0.214	BSC	
L	19.80	20.10	0.78	0.79	
L1	-	4.30	-	0.17	
М	0.35	0.95	0.01	0.04	
Р	3.40	3.60	0.13	0.14	
P1	7.00	7.40	0.28	0.29	
P2	2.40	2.60	0.09	0.10	
Q	5.60	6.00	0.22	0.24	
S	6.05	6.25	0.24	0.25	
Т	9.80	10.20	0.39	0.40	
U	6.00	6.40	0.24	0.25	



Pb Free Product NCE30TD60BT

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